

SANYO Semiconductors DATA SHEET

5HP01M-

P-Channel Silicon MOSFET

PO1M — General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Ultrahigh-speed switching.
- · 4V drive.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		-50	V
Gate-to-Source Voltage	VGSS		±20	٧
Drain Current (DC)	ID		-0.07	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	-0.28	Α
Allowable Power Dissipation	PD		0.15	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0V	-50			V
Zero-Gate Voltage Drain Current	IDSS	VDS=-50V, VGS=0V			-1	μΑ
Gate-to-Sourse Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =-10V, I _D =-100μA	-1		-2.5	V
Forward Transfer Admittance	yfs	VDS=-10V, ID=-40mA	50	70		mS
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =-40mA, V _G S=-10V		17	22	Ω
	R _{DS} (on)2	I _D =-20mA, V _G S=-4V		23	32	Ω
Input Capacitance	Ciss	VDS=-10V, f=1MHz		6.2		pF
Output Capacitance	Coss	V _{DS} =-10V, f=1MHz		4.0		pF
Reverse Transfer Capacitance	Crss	VDS=-10V, f=1MHz		1.3		pF

Marking: XC Continued on next page.

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5HP01M

Continued from preceding page. Parameter	Oh. al	Conditions	Ratings			1.1
	Symbol		min	typ	max	Unit
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		13		ns
Rise Time	t _r	See specified Test Circuit.		10		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		100		ns
Fall Time	tf	See specified Test Circuit.		150		ns
Total Gate Charge	Qg	V _{DS} =-10V, V _{GS} =-10V, I _D =-70mA		1.32		nC
Gate Source Charge	Qgs	VDS=-10V, VGS=-10V, ID=-70mA		0.17		nC
Gate Drain Charge	Qgd	V _{DS} =-10V, V _{GS} =-10V, I _D =-70mA		0.34		nC

Is=-70mA, VGS=0V

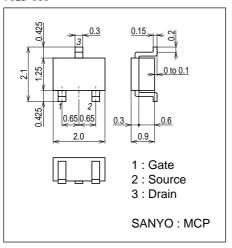
VSD

Package Dimensions

Diode Forward Voltage

unit : mm 7023-010

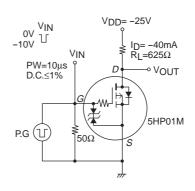
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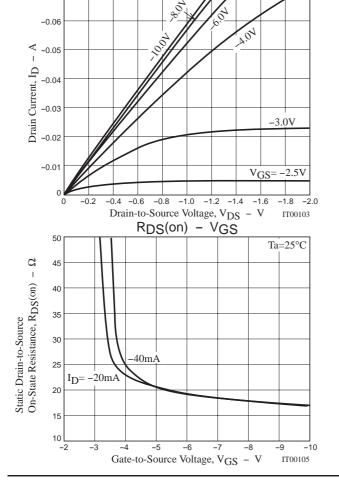


Switching Time Test Circuit

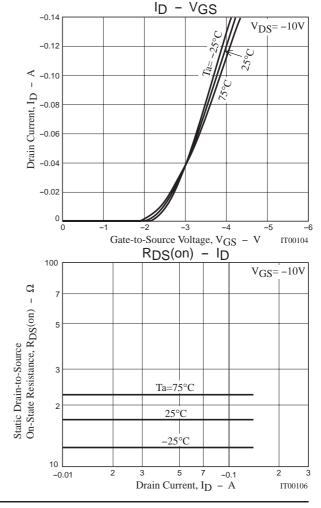
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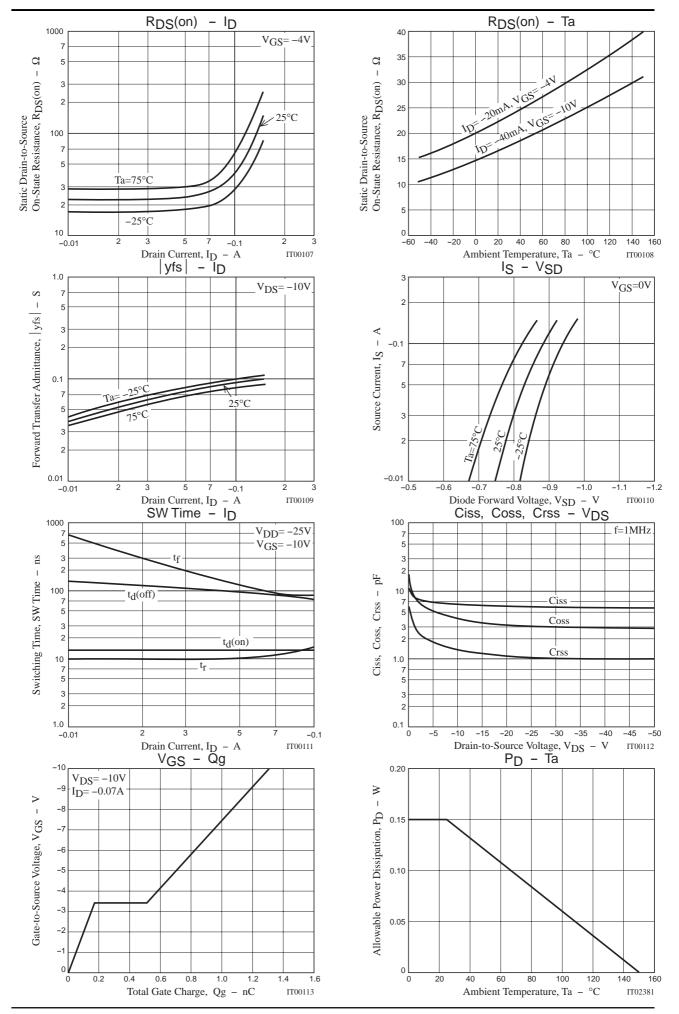
-1.2





ID - VDS





Note on usage: Since the 5HP01M is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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